

# HDMI05-CL02F3

## 5-line IPAD<sup>™</sup>, HDMI<sup>™</sup> control line ESD protection

### Features

- Low line capacitance: 12 pF max.
- High efficiency in ESD protection
- Lead-free package
- Very thin package
- High reliability offered by monolithic integration
- High reduction of parasitic elements through integration and wafer level packaging

### Complies with the standards:

- IEC 61000-4-2 Level 4
  - ± 15 kV (air discharge)
  - ± 8 kV (contact discharge)
- IEC 61000-4-2 Level 1
  - ± 2 kV (air discharge)
  - ± 2 kV (contact discharge)

## Application

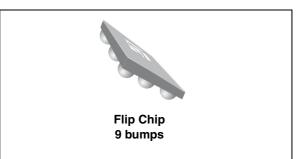
Where ESD protection for HDMI control lines (CEC, HPD, SCL and SDA) is required:

- Mobile phones and communication systems
- Portable multimedia players
- Camcorder, digital still cameras

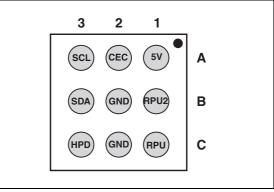
### Description

The HDMI05-CL02F3 chip is a low capacitance ESD protection for HDMI control pins. It also integrates pull-up resistor for I<sup>2</sup>C bus and pull-down resistor for hot plug detect and pull-up resistor for CEC line.

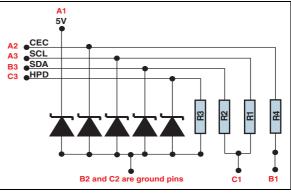
The ESD protection circuitry prevents damage to the protected device when subjected to ESD surges up to 15 kV.



#### Figure 1. Pin configuration (bump side)







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# 1 Characteristics

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### Table 1.Absolute maximum ratings ( $T_{amb} = 25 \ ^{\circ}C$ )

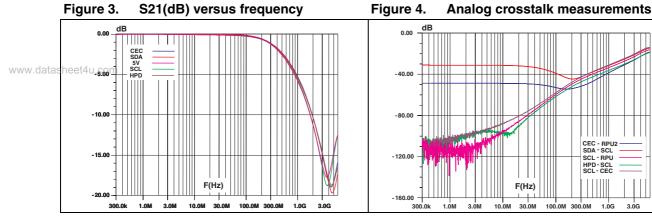
Symbol	Parameter	Value	Unit
V <sub>PP</sub>	External pins (A1, A2, A3, B3 and C3): ESD IEC 61000-4-2, level 4 - air discharge ESD IEC 61000-4-2, level 4 - contact discharge Internal pins (B1, C1): ESD IEC 61000-4-2, level 1 - air discharge ESD IEC 61000-4-2, level 1 - contact discharge	15 8 2 2	kV
Pd	Line resistance power dissipation at 70 °C	60	mW
T <sub>op</sub>	Operating temperature range	-30 to + 85	°C
T <sub>stg</sub>	Storage temperature range	-55 to + 150	°C

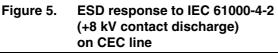
### Table 2. Electrical characteristics ( $T_{amb} = 25 \ ^{\circ}C$ )

Table 2.	Electrical characteristics $(T_{amb} = 25 C)$					
Symbol	Parameter		I	<b>▲</b> .		
V <sub>BR</sub>	Breakdown voltage		IF			
I <sub>RM</sub>	Leakage current @ V <sub>RM</sub>					
V <sub>RM</sub>	Stand-off voltage				VF	
V <sub>CL</sub>	Clamping voltage				¥ → V	
R <sub>d</sub>	Dynamic impedance	Slope = 1/R <sub>d</sub>				
I <sub>PP</sub>	Peak pulse current					
R <sub>I/O</sub>	Series resistance between Input and Output			IPP		
C <sub>line</sub>	Line capacitance					
Symbol	Test condition	Min	Тур	Max	Unit	
V <sub>BR</sub>	I <sub>R</sub> = 1 mA	6		20	V	
I <sub>RM</sub>	V <sub>RM</sub> = 3 V per line		50	200	nA	
R <sub>1</sub> , R <sub>2</sub>		1575	1750	1925	Ω	
R <sub>3</sub>		80	100	120	kΩ	
R <sub>4</sub>		22	27	32	kΩ	
C <sub>line</sub>	$\label{eq:Vline} \begin{array}{l} V_{line} = 0 \ V, \ V_{osc} = 30 \ mV, \ F = 1 \ MHz \\ CEC \ to \ GND \ with \ R_{PU2} \ not \ connected \\ SCL \ and \ SDA \ to \ GND \ with \ R_{PU} \ not \ connected \\ (measured under zero light conditions) \end{array}$		14 24	17 29	pF	
C <sub>line</sub> <sup>(1)</sup>	$V_{line} = 0 V$ , $V_{osc} = 30 mV$ , F = 1 MHz CEC, SCL and SDA to GND with $R_{PU}$ and $R_{PU2}$ grounded (measured under zero light conditions)		10	12	pF	

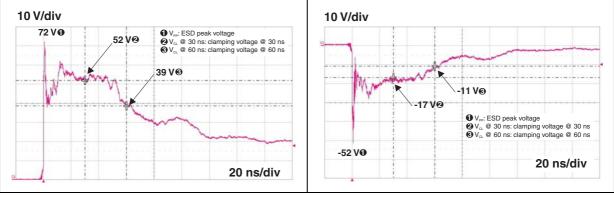
1. This is the line capacitance seen by the data signals in the application conditions

CEC - RPU2 SDA - SCL SCL - RPU HPD - SCL SCL - CEC





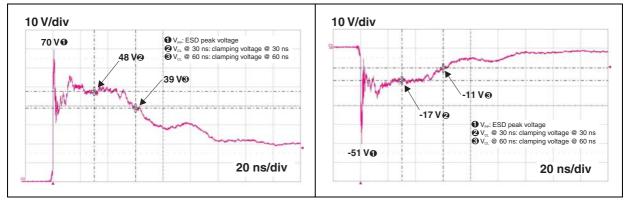




#### Figure 7. ESD response to IEC 61000-4-2 (+8 kV contact discharge) on SCL line

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Rev 1

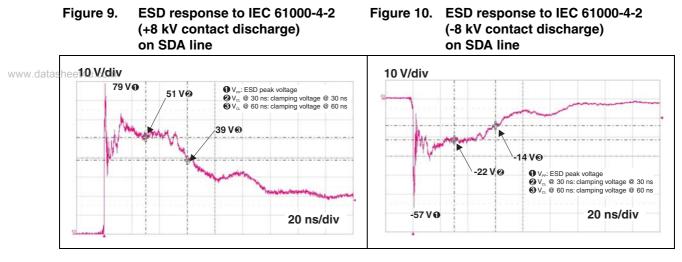
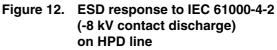


Figure 11. ESD response to IEC 61000-4-2 (+8 kV contact discharge) on HPD line



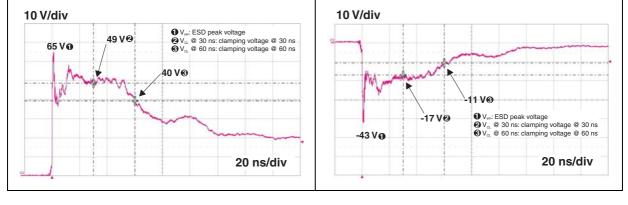
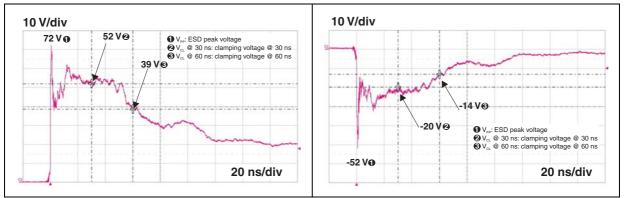


Figure 13. ESD response to IEC 61000-4-2 (+8 kV contact discharge) on 5 V line

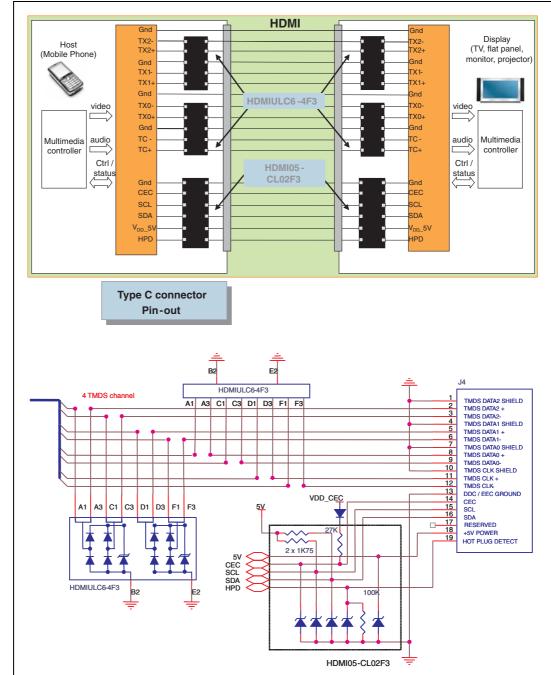
Figure 14. ESD response to IEC 61000-4-2 (-8 kV contact discharge) on 5 V line



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### 2

# Typical application schematic

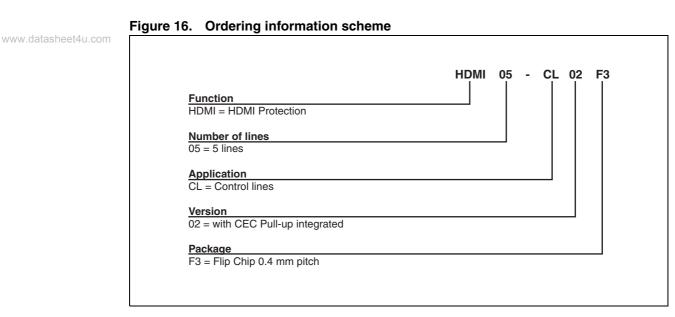


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### Figure 15. Implementation with HDMI



## **3** Ordering information scheme



## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <u>www.st.com</u>. ECOPACK<sup>®</sup> is an ST trademark.

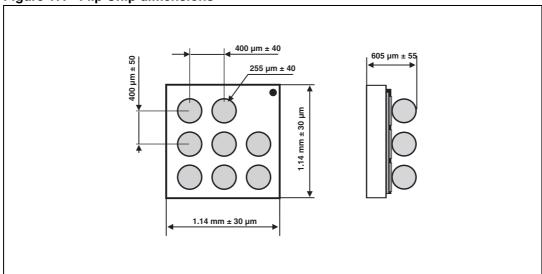
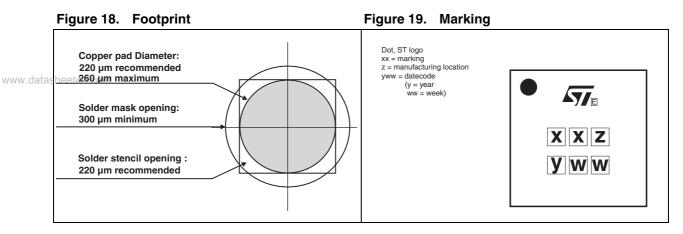


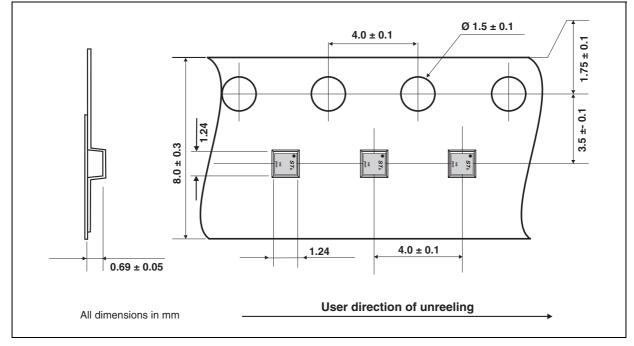
Figure 17. Flip Chip dimensions

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## 5 Ordering information

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#### Table 3.Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
HDMI05-CL02F3	JG	Flip Chip	1.76 mg	5000	Tape and reel (7")

## 6 Revision history

#### Table 4.Document revision history

Date	Revision	Changes
24-Mar-2009	1	First issue.



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